



## Customer Information Notification

202010005I

**Issue Date:** 08-Oct-2020

**Effective Date:** 09-Oct-2020

Here's your personalized quality information concerning products Digi-Key purchased from NXP. For detailed information we invite you to view this notification online

**This notice is NXP Company Proprietary.**



# QUALITY

### Management Summary

Continuing customer communication regarding NXP Semiconductors Oak Hill Fab Scale Down for Pressure and Motion Sensor products.

### Change Category

- |  |   |  |   |   |
|--|---|--|---|---|
| <input type="checkbox"/> Wafer Fab Process             | <input type="checkbox"/> Assembly Process   | <input type="checkbox"/> Product Marking           | <input type="checkbox"/> Test Location  | <input type="checkbox"/> Design                         |
| <input type="checkbox"/> Wafer Fab Materials           | <input type="checkbox"/> Assembly Materials | <input type="checkbox"/> Mechanical Specification  | <input type="checkbox"/> Test Process   | <input type="checkbox"/> Errata                         |
| <input checked="" type="checkbox"/> Wafer Fab Location | <input type="checkbox"/> Assembly Location  | <input type="checkbox"/> Packing/Shipping/Labeling | <input type="checkbox"/> Test Equipment | <input type="checkbox"/> Electrical spec./Test coverage |
| <input type="checkbox"/> Firmware                      | <input type="checkbox"/> Other              |  |   |   |

NXP Semiconductors Oak Hill Fab Scale Down: Customer Information Notification - Pressure and Motion Sensor Products

### Description

Through the General Notification, 202009009G, issued 11 Sept 2020, NXP informed you that the Pressure and Motion Sensor products, among other devices currently manufactured at Oak Hill Fab, will either be transferred to an alternate wafer fab, or transitioned to end-of-life (EOL) status, and that additional details would be communicated by 25 September 2020. A specific Discontinuation Notification, 202009030DN, was issued 26 Sept 2020 for some of those devices that will be end-of-life without a transition plan. However, the details and official notification for the remaining products is now delayed until the end of October 2020 as NXP continues to collect customer feedback. This Customer Information Notification 202010005I serves to identify those Pressure and Motion Sensor products still pending disposition details for your awareness and advanced planning.

## Reason

Continuing customer communication regarding NXP Semiconductors Oak Hill Fab Scale Down for Pressure and Motion Sensor products still pending disposition details.

## Identification of Affected Products

See the attached affected products list and corresponding product remarks - no additional product details to be relayed at this time.

## Anticipated Impact on Form, Fit, Function, Reliability or Quality

Any impact on form, fit, function, reliability or quality, will be relayed at a later time with additional disposition details.

## Related Notifications

Notification	Issue Date	Effective Date	Title
--------------	------------	----------------	-------

202009009G	11-Sep-2020		NXP Semiconductors Will Scale Down Operations at Oak Hill Fab
202009030DN	26-Sep-2020	27-Sep-2020	NXP Semiconductors Oak Hill Fab Scale Down: Product Discontinuation Notification - Analog, Sensors, Edge Processing

## Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.

Customer Focus, Passion to Win.

NXP Quality Management Team.

## About NXP Semiconductors

NXP Semiconductors N.V. (NASDAQ: NXPI) provides High Performance Mixed Signal and Standard Product solutions that leverage its leading RF, Analog, Power Management, Interface, Security and Digital Processing expertise. These innovations are used in a wide range of automotive, identification, wireless infrastructure, lighting, industrial, mobile, consumer and computing applications.

You have received this email because you are a designated contact or subscribed to NXP Quality Notifications. NXP shall not be held liable if this Notification is not correctly distributed within your organization.

This message has been automatically distributed. Please do not reply.

[View Notification](#)

[Subscription](#)

[Support](#)

[NXP](#) | [Privacy Policy](#) | [Terms of Use](#)

NXP Semiconductors  
High Tech Campus, 5656 AG Eindhoven, The Netherlands

© 2006-2010 NXP Semiconductors. All rights reserved.

**Affected Part Numbers**

MPL3115A2R1  
MPL3115A2  
FXTH871511DT1  
FXPQ3115BVT1  
FXTH8709116T1  
FXTH87EH118T1  
MPL115A2T1  
MPL115A2  
MPL115A1T1  
FXTH87EH11DT1  
FXTH87EH116T1  
MMA6527KCWR2

**Affected 12NC**

935310992115  
935310992157  
935312081528  
935312517115  
935315035528  
935341038528  
935319485115  
935319485157  
935322928115  
935340541528  
935340863528  
935315604528